## LIXYS

### TrenchMV<sup>™</sup> IXTF230N085T Power MOSFET (Electrically Isolated Back Surface)

N-Channel Enhancement Mode Avalanche Rated

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Symbol	<b>Test Conditions</b>	Maximum	Ratings
V <sub>DSS</sub>	T <sub>1</sub> = 25°C to 175°C	85	V
	$T_{J}^{\circ}$ = 25°C to 175°C; $R_{GS}$ = 1 M $\Omega$	55	V
V <sub>GSM</sub>	Transient	± 20	V
I <sub>D25</sub>	T <sub>c</sub> = 25°C	130	А
I_	Package Current Limit, RMS (75 A per lead	l) 150	А
I <sub>DM</sub>	$T_c = 25^{\circ}C$ , pulse width limited by $T_{JM}$	520	А
I <sub>AR</sub>	T <sub>c</sub> = 25°C	40	A
E <sub>AS</sub>	$T_c$ = 25°C	1.5	J
dv/dt	$\begin{split} I_{_{S}} &\leq I_{_{DM}}, \text{di/dt} \leq 100 \text{ A/ms}, \text{ V}_{_{DD}} \leq \text{V}_{_{DSS}} \\ T_{_{J}} &\leq 175^{\circ}\text{C}, \text{ R}_{_{G}} = 3.3 \ \Omega \end{split}$	3	V/ns
P <sub>D</sub>	$T_c = 25^{\circ}C$	200	W
T,		-55 +175	°C
T_ĭ		175	°C
T <sub>stg</sub>		-55 +175	°C
T	1.6 mm (0.062 in.) from case for 10 s	300	°C
	Plastic body for 10 seconds	260	°C
V <sub>ISOL</sub>	50/60 Hz, t = 1 minute, $I_{ISOL}$ < 1 mA, RMS 250	00 V	
F <sub>c</sub>	Mounting force 20	)120/4.525	N/lb.
Weight		6	g

Symbol	<b>Test Conditions</b>		<b>Characteristic Values</b>			es
$(T_{J} = 25^{\circ}C)$	unless otherwise specified)		Min.	Тур.	Max.	
BV <sub>DSS</sub>	$V_{_{GS}} = 0 \text{ V}, \text{ I}_{_{D}} = 250 \text{ mA}$		85			V
V <sub>GS(th)</sub>	$V_{_{DS}} = V_{_{GS}}, I_{_{D}} = 250 \text{ mA}$		2.0		4.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$				± 200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T <sub>J</sub> = 150°C			5 250	μΑ μΑ
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}, \text{ Notes}$	s 1, 2			5.3 ו	mΩ

SOPLUS i4-Pak<sup>™</sup> (5-lead) (IXTF)

85

130

5.3 mΩ

=

 $\leq$ 

V

Α

D G = Gate D = Drain S = Source

#### Features

V<sub>DSS</sub>

D25

R<sub>DS(on)</sub>

- Ultra-low On Resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
   easy to drive and to protect
- 175 °C Operating Temperature

#### Advantages

- Easy to mount
- Space savings
- High power density

#### Applications

- Automotive
  - Motor Drives
  - 42V Power Bus
  - ABS Systems
- DC/DC Converters and Off-line UPS
- Primary Switch for 24V and 48V Systems
- Distributed Power Architechtures and VRMs
- Electronic Valve Train Systems
- High Current Switching Applications
- High Voltage Synchronous Recifier

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### **IXTF230N085T**

Symbol	$(T_J = 25^{\circ}C \text{ unle})$		teristic \ herwise Typ.		ISOPLUS i4-Pak™ (5-Lead) (IXTF) Outline
<b>g</b> <sub>fs</sub>	$V_{DS}$ = 10 V; I <sub>D</sub> = 60 A, Note 1	75	125	S	E
C <sub>iss</sub>			9900	pF	
C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$		1230	pF	
C <sub>rss</sub>			286	pF	
t <sub>d(on)</sub>			32	ns	
t,	$V_{_{ m GS}} = 10 \text{ V}, \text{ V}_{_{ m DS}} = 0.5 \text{ V}_{_{ m DSS}}, \text{ I}_{_{ m D}} = 50 \text{ A}$		49	ns	
t <sub>d(off)</sub>	$R_{g} = 3.3 \Omega$ (External)		56	ns	
t <sub>r</sub>			39	ns	
Q <sub>g(on)</sub>			187	nC	
$\mathbf{Q}_{gs}$	$V_{gS} = 10 \text{ V}, \text{ V}_{DS} = 0.5 \text{ V}_{DSS}, \text{ I}_{D} = 25 \text{ A}$		51	nC	
<b>Q</b> <sub>gd</sub>			55	nC	
$R_{_{\mathrm{thJC}}}$				0.75 °C/W	
R <sub>thCH</sub>			0.15	°C/W	

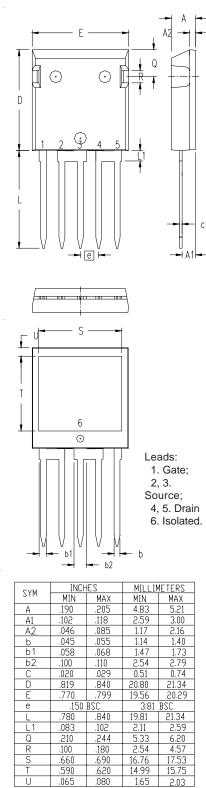
Source-Drain Diode		<b>Characteristic Values</b> T <sub>1</sub> = 25°C unless otherwise specified)					
Symbol	<b>Test Conditions</b>	Min.   Typ.   Max.					
I <sub>s</sub>	$V_{GS} = 0 V$			150	Α		
I <sub>SM</sub>	Pulse width limited by $T_{_{JM}}$			520	А		
V <sub>SD</sub>	$I_{F} = 50 \text{ A}, V_{GS} = 0 \text{ V}, \text{ Note } 1$			1.0	V		
t <sub>rr</sub>	I <sub>F</sub> = 25 A, -di/dt = 100 A/μs		60		ns		
	$V_{R} = 50 \text{ V},  V_{GS} = 0 \text{ V}$						

Notes: 1. Pulse test:  $t \le 300 \ \mu$ s, duty cycled  $\le 2 \%$ ;

2. Drain and Source Kelvin contacts must be located less than 5 mm from the plastic body.

#### **ADVANCETECHNICALINFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



All leads and tab are tin plated.

1.65

203

.065

IXYS MOSFETs and IGBTs are covered by	4.835.592	4.931.844	5.049.961	5.237.481	6.162.665	6.404.065 B1	6.683.344	6.727.585	7.005.734B2
one or moreof the following U.S. patents:		5.017.508	5.063.307	5.381.025	6.259.123B1	6.534.343	6.710.405B2	6.759.692	7.063.975B2
3	4.881,106	5,034,796	5.187.117	5.486.715	6,306,728 B1	6.583.505	6.710.463	6771478B2	7.071.537